

## Resonant Switching Series

Reverse conducting IGBT with monolithic body diode

IHW30N110R3

Data sheet

Industrial Power Control

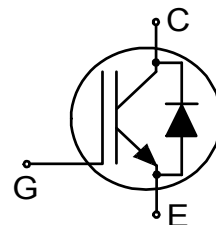
## Reverse conducting IGBT with monolithic body diode

### Features:

- Powerful monolithic body diode with low forward voltage designed for soft commutation only
- Very tight parameter distribution
- High ruggedness, temperature stable behavior
- Low  $V_{CEsat}$
- Easy parallel switching capability due to positive temperature coefficient in  $V_{CEsat}$
- Low EMI
- Qualified according to JEDEC for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models:  
<http://www.infineon.com/igbt/>

### Applications:

- Inductive cooking
- Inverterized microwave ovens
- Resonant converters
- Soft switching applications



### Key Performance and Package Parameters

| Type        | $V_{CE}$ | $I_C$ | $V_{CEsat}$ , $T_{vj}=25^{\circ}C$ | $T_{vjmax}$ | Marking  | Package    |
|-------------|----------|-------|------------------------------------|-------------|----------|------------|
| IHW30N110R3 | 1100V    | 30A   | 1.55V                              | 175°C       | H30R1103 | PG-TO247-3 |

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### Maximum Ratings

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

| Parameter                                                                                              | Symbol      | Value                | Unit             |
|--------------------------------------------------------------------------------------------------------|-------------|----------------------|------------------|
| Collector-emitter voltage                                                                              | $V_{CE}$    | 1100                 | V                |
| DC collector current, limited by $T_{vjmax}$<br>$T_C = 25^\circ\text{C}$<br>$T_C = 100^\circ\text{C}$  | $I_C$       | 60.0<br>30.0         | A                |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$                                                 | $I_{Cpuls}$ | 90.0                 | A                |
| Turn off safe operating area $V_{CE} \leq 1100\text{V}$ , $T_{vj} \leq 175^\circ\text{C}$              | -           | 90.0                 | A                |
| Diode forward current, limited by $T_{vjmax}$<br>$T_C = 25^\circ\text{C}$<br>$T_C = 100^\circ\text{C}$ | $I_F$       | 60.0<br>30.0         | A                |
| Diode pulsed current, $t_p$ limited by $T_{vjmax}$                                                     | $I_{Fpuls}$ | 90.0                 | A                |
| Gate-emitter voltage<br>Transient Gate-emitter voltage ( $t_p \leq 10\mu\text{s}$ , $D < 0.010$ )      | $V_{GE}$    | $\pm 20$<br>$\pm 25$ | V                |
| Power dissipation $T_C = 25^\circ\text{C}$<br>Power dissipation $T_C = 100^\circ\text{C}$              | $P_{tot}$   | 333.0<br>166.0       | W                |
| Operating junction temperature                                                                         | $T_{vj}$    | $-40 \dots +175$     | $^\circ\text{C}$ |
| Storage temperature                                                                                    | $T_{stg}$   | $-55 \dots +175$     | $^\circ\text{C}$ |
| Soldering temperature,<br>wave soldering 1.6mm (0.063in.) from case for 10s                            |             | 260                  | $^\circ\text{C}$ |
| Mounting torque, M3 screw<br>Maximum of mounting processes: 3                                          | $M$         | 0.6                  | Nm               |

### Thermal Resistance

| Parameter                                    | Symbol        | Conditions | Max. Value | Unit |
|----------------------------------------------|---------------|------------|------------|------|
| <b>Characteristic</b>                        |               |            |            |      |
| IGBT thermal resistance,<br>junction - case  | $R_{th(j-c)}$ |            | 0.45       | K/W  |
| Diode thermal resistance,<br>junction - case | $R_{th(j-c)}$ |            | 0.45       | K/W  |
| Thermal resistance<br>junction - ambient     | $R_{th(j-a)}$ |            | 40         | K/W  |

**Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified**

| Parameter                            | Symbol        | Conditions                                                                                                    | Value       |                      |                | Unit     |
|--------------------------------------|---------------|---------------------------------------------------------------------------------------------------------------|-------------|----------------------|----------------|----------|
|                                      |               |                                                                                                               | min.        | typ.                 | max.           |          |
| Static Characteristic                |               |                                                                                                               |             |                      |                |          |
| Collector-emitter breakdown voltage  | $V_{(BR)CES}$ | $V_{GE} = 0V, I_C = 0.50mA$                                                                                   | 1100        | -                    | -              | V        |
| Collector-emitter saturation voltage | $V_{CEsat}$   | $V_{GE} = 15.0V, I_C = 30.0A$<br>$T_{vj} = 25^{\circ}C$<br>$T_{vj} = 125^{\circ}C$<br>$T_{vj} = 175^{\circ}C$ | -<br>-<br>- | 1.55<br>1.85<br>2.00 | 1.75<br>-<br>- | V        |
| Diode forward voltage                | $V_F$         | $V_{GE} = 0V, I_F = 30.0A$<br>$T_{vj} = 25^{\circ}C$<br>$T_{vj} = 125^{\circ}C$<br>$T_{vj} = 175^{\circ}C$    | -<br>-<br>- | 1.35<br>1.38<br>1.41 | 1.55<br>-<br>- | V        |
| Gate-emitter threshold voltage       | $V_{GE(th)}$  | $I_C = 0.70mA, V_{CE} = V_{GE}$                                                                               | 5.1         | 5.8                  | 6.4            | V        |
| Zero gate voltage collector current  | $I_{CES}$     | $V_{CE} = 1100V, V_{GE} = 0V$<br>$T_{vj} = 25^{\circ}C$<br>$T_{vj} = 175^{\circ}C$                            | -<br>-      | -<br>-               | 5.0<br>2500.0  | $\mu A$  |
| Gate-emitter leakage current         | $I_{GES}$     | $V_{CE} = 0V, V_{GE} = 20V$                                                                                   | -           | -                    | 100            | nA       |
| Transconductance                     | $g_{fs}$      | $V_{CE} = 20V, I_C = 30.0A$                                                                                   | -           | 15.0                 | -              | S        |
| Integrated gate resistor             | $r_G$         |                                                                                                               |             | none                 |                | $\Omega$ |

**Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified**

| Parameter                                                      | Symbol           | Conditions                                                            | Value |       |      | Unit |
|----------------------------------------------------------------|------------------|-----------------------------------------------------------------------|-------|-------|------|------|
|                                                                |                  |                                                                       | min.  | typ.  | max. |      |
| Dynamic Characteristic                                         |                  |                                                                       |       |       |      |      |
| Input capacitance                                              | C <sub>ies</sub> | V <sub>CE</sub> = 25V, V <sub>GE</sub> = 0V, f = 1MHz                 | -     | 1460  | -    | pF   |
| Output capacitance                                             | C <sub>oes</sub> |                                                                       | -     | 55    | -    |      |
| Reverse transfer capacitance                                   | C <sub>res</sub> |                                                                       | -     | 45    | -    |      |
| Gate charge                                                    | Q <sub>G</sub>   | V <sub>CC</sub> = 880V, I <sub>C</sub> = 30.0A, V <sub>GE</sub> = 15V | -     | 180.0 | -    | nC   |
| Internal emitter inductance measured 5mm (0.197 in.) from case | L <sub>E</sub>   |                                                                       | -     | 13.0  | -    | nH   |

**Switching Characteristic, Inductive Load**

| Parameter | Symbol | Conditions | Value |      |      | Unit |
|-----------|--------|------------|-------|------|------|------|
|           |        |            | min.  | typ. | max. |      |

**IGBT Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$** 

|                     |              |                                                                                                                                                                                                                                                                                                             |   |      |   |    |
|---------------------|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|------|---|----|
| Turn-off delay time | $t_{d(off)}$ | $T_{vj} = 25^{\circ}\text{C}, V_{CC} = 600\text{V}, I_C = 30.0\text{A}, V_{GE} = 0.0/15.0\text{V}, R_{G(on)} = 15.0\Omega, R_{G(off)} = 15.0\Omega, L_{\sigma} = 80\text{nH}, C_{\sigma} = 39\text{pF}$<br>$L_{\sigma}, C_{\sigma}$ from Fig. E<br>Energy losses include "tail" and diode reverse recovery. | - | 350  | - | ns |
| Fall time           | $t_f$        |                                                                                                                                                                                                                                                                                                             | - | 16   | - | ns |
| Turn-off energy     | $E_{off}$    |                                                                                                                                                                                                                                                                                                             | - | 1.15 | - | mJ |

**Switching Characteristic, Inductive Load**

| Parameter                                              | Symbol              | Conditions                                                                                                                                                                                                                                                                                                                                         | Value |      |      | Unit |
|--------------------------------------------------------|---------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|------|------|
|                                                        |                     |                                                                                                                                                                                                                                                                                                                                                    | min.  | typ. | max. |      |
| IGBT Characteristic, at $T_{vj} = 175^{\circ}\text{C}$ |                     |                                                                                                                                                                                                                                                                                                                                                    |       |      |      |      |
| Turn-off delay time                                    | $t_{d(\text{off})}$ | $T_{vj} = 175^{\circ}\text{C}$ ,<br>$V_{CC} = 600\text{V}$ , $I_C = 30.0\text{A}$ ,<br>$V_{GE} = 0.0/15.0\text{V}$ ,<br>$R_{G(\text{on})} = 15.0\Omega$ , $R_{G(\text{off})} = 15.0\Omega$ ,<br>$L\sigma = 80\text{nH}$ , $C\sigma = 39\text{pF}$<br>$L\sigma$ , $C\sigma$ from Fig. E<br>Energy losses include “tail” and diode reverse recovery. | -     | 410  | -    | ns   |
| Fall time                                              | $t_f$               |                                                                                                                                                                                                                                                                                                                                                    | -     | 60   | -    | ns   |
| Turn-off energy                                        | $E_{\text{off}}$    |                                                                                                                                                                                                                                                                                                                                                    | -     | 1.80 | -    | mJ   |

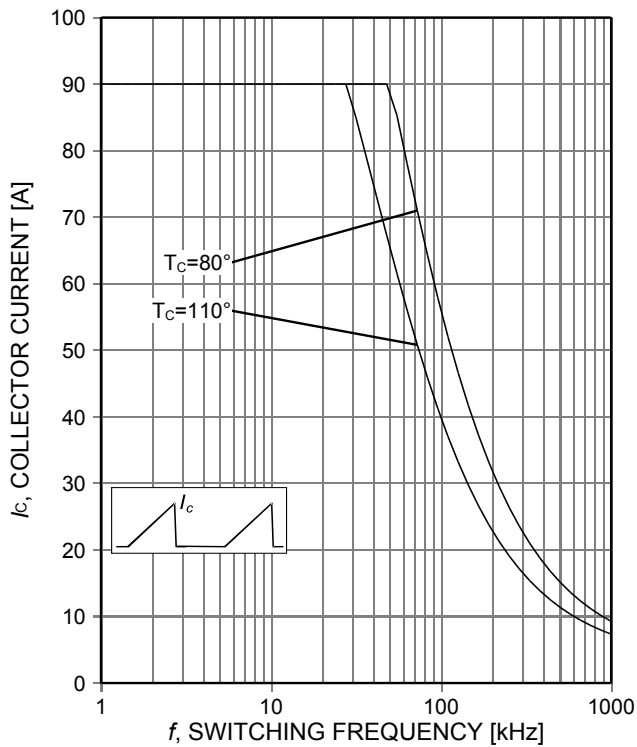


Figure 1. **Collector current as a function of switching frequency**  
 $(T_j \leq 175^\circ\text{C}, D=0.5, V_{CE}=600\text{V}, V_{GE}=0/15\text{V}, R_G=15\Omega)$

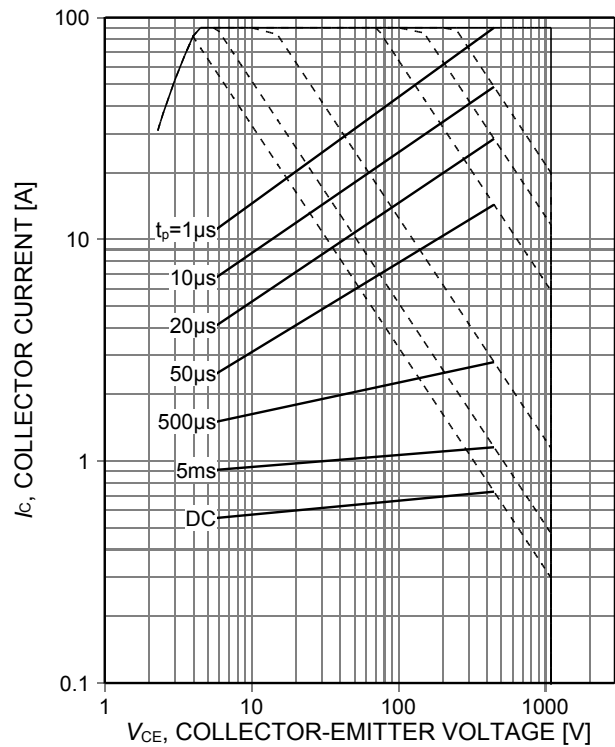


Figure 2. **Forward bias safe operating area**  
 $(D=0, T_C=25^\circ\text{C}, T_j \leq 175^\circ\text{C}; V_{GE}=15\text{V})$

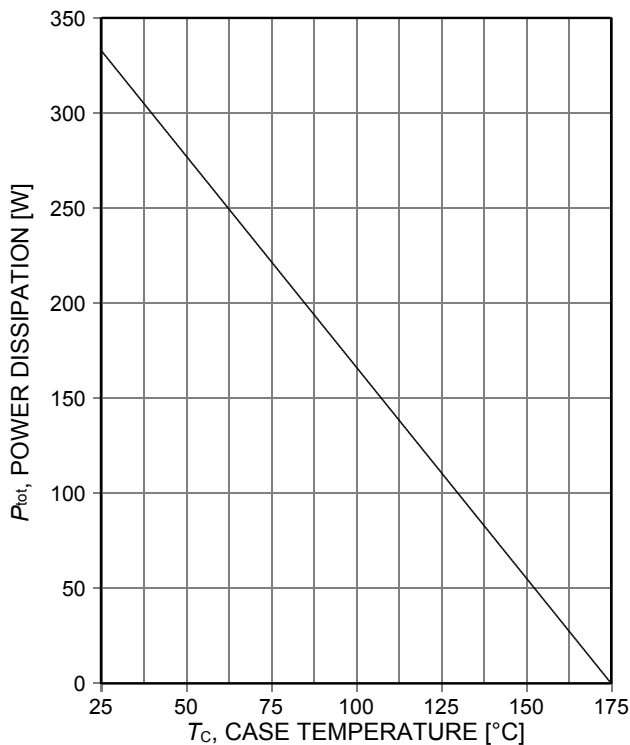


Figure 3. **Power dissipation as a function of case temperature**  
 $(T_j \leq 175^\circ\text{C})$

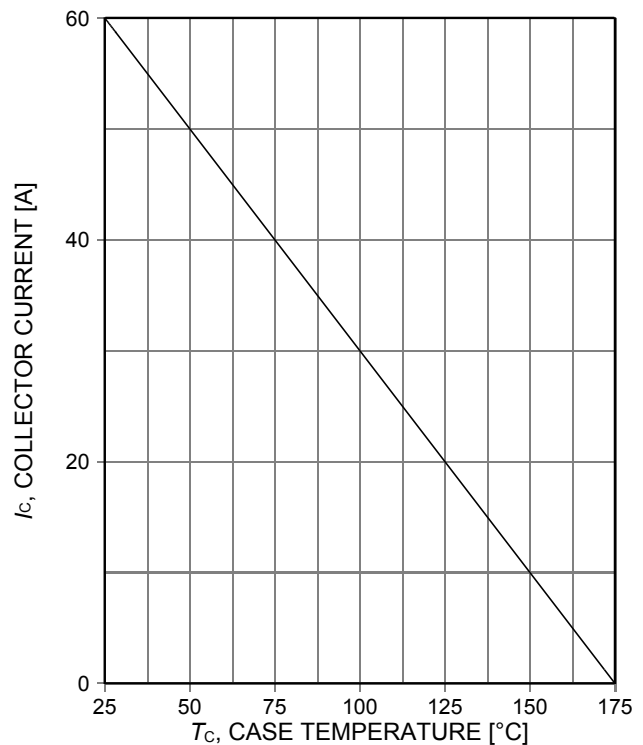


Figure 4. **Collector current as a function of case temperature**  
 $(V_{GE} \geq 15\text{V}, T_j \leq 175^\circ\text{C})$

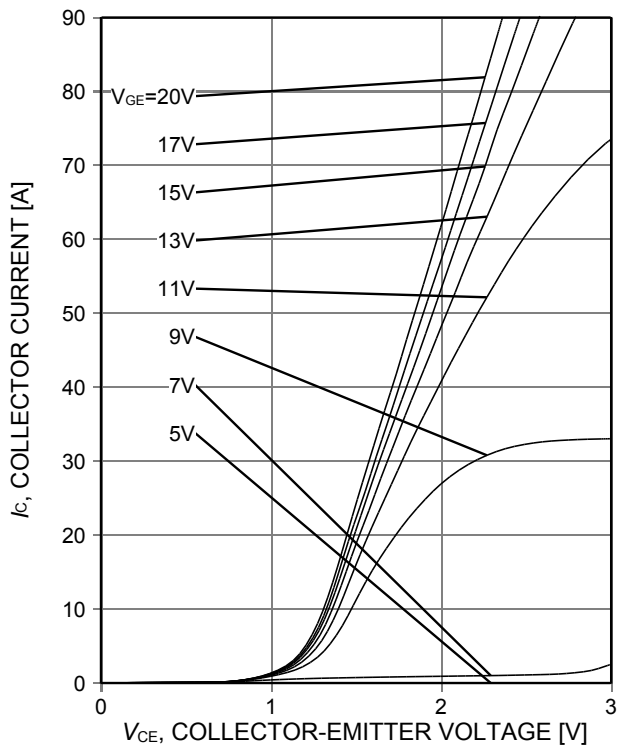


Figure 5. **Typical output characteristic**  
( $T_j=25^\circ\text{C}$ )

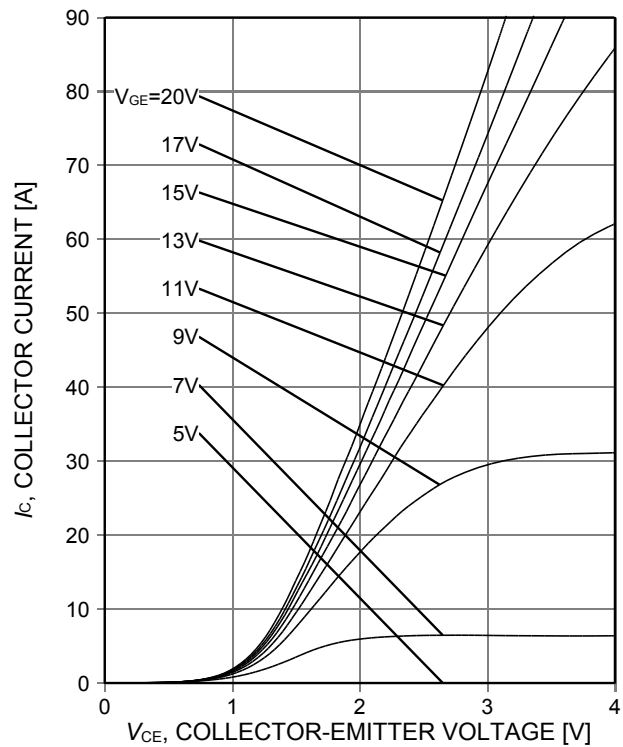


Figure 6. **Typical output characteristic**  
( $T_j=175^\circ\text{C}$ )

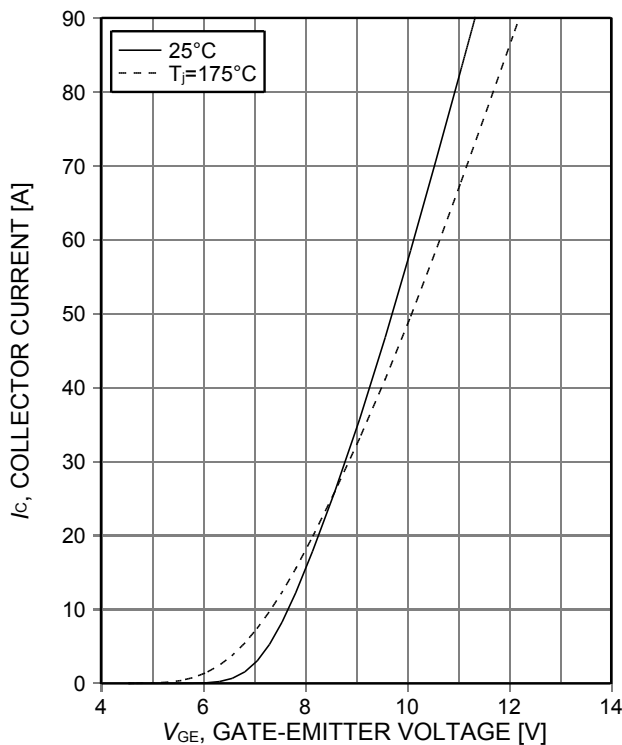


Figure 7. **Typical transfer characteristic**  
( $V_{CE}=20\text{V}$ )

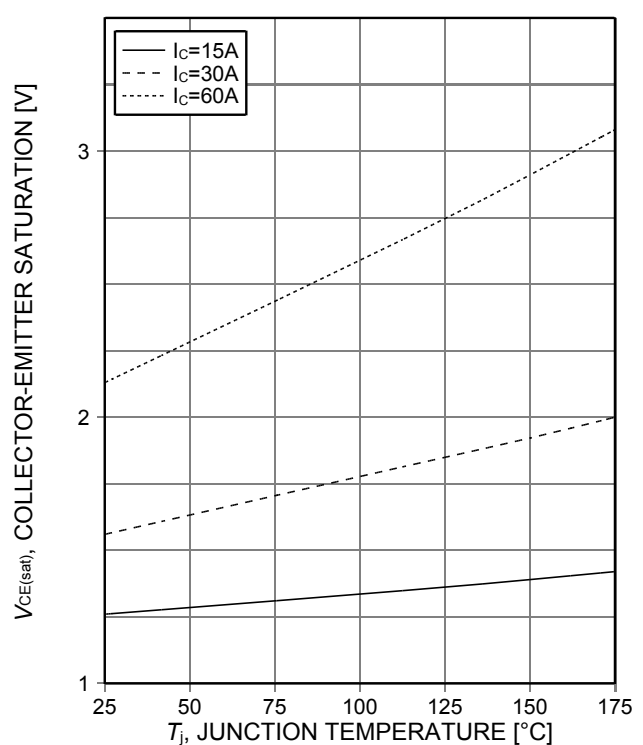


Figure 8. **Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE}=15\text{V}$ )

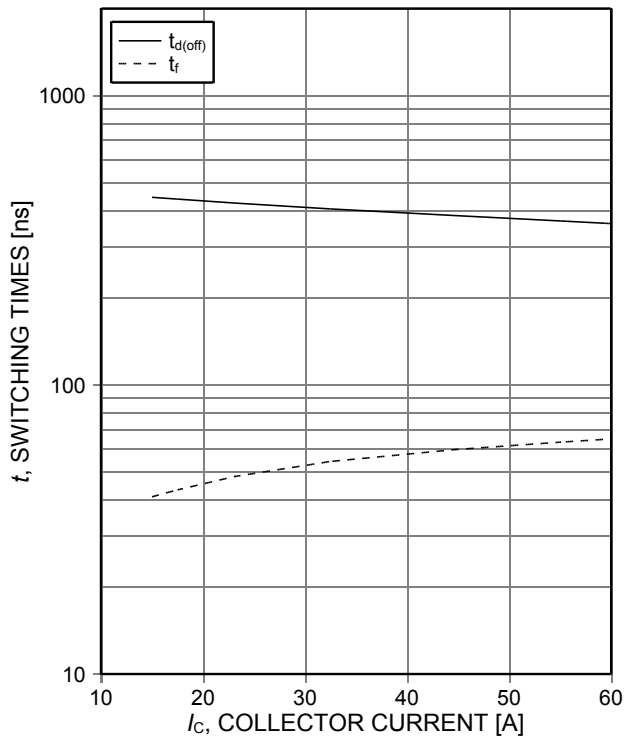


Figure 9. **Typical switching times as a function of collector current**  
(ind. load,  $T_J=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $R_{G(on)}=15\Omega$ ,  $R_{G(off)}=15\Omega$ , test circuit in Fig. E)

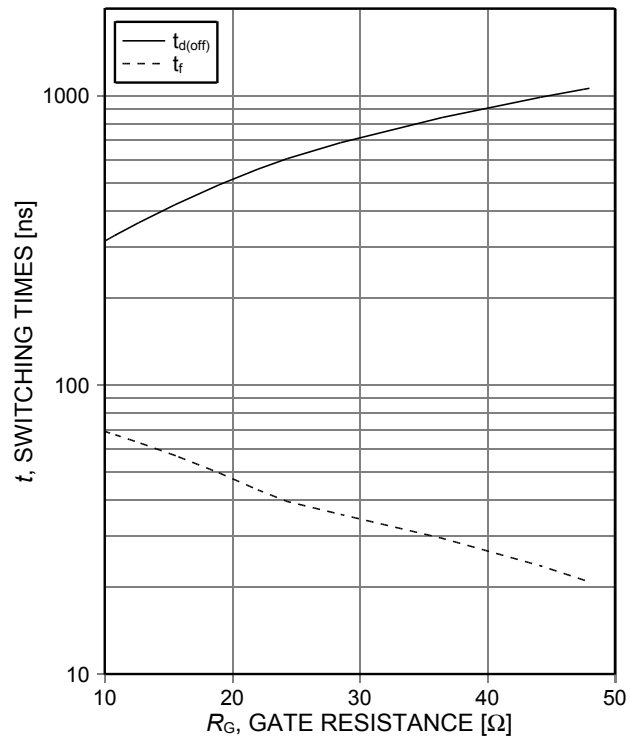


Figure 10. **Typical switching times as a function of gate resistance**  
(ind. load,  $T_J=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=30\text{A}$ , test circuit in Fig. E)

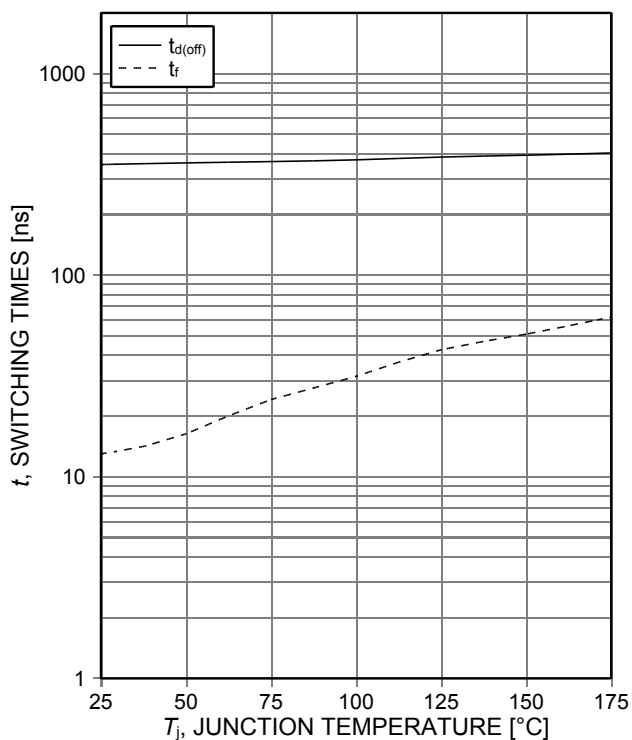


Figure 11. **Typical switching times as a function of junction temperature**  
(ind. load,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=30\text{A}$ ,  $R_{G(on)}=15\Omega$ ,  $R_{G(off)}=15\Omega$ , test circuit in Fig. E)

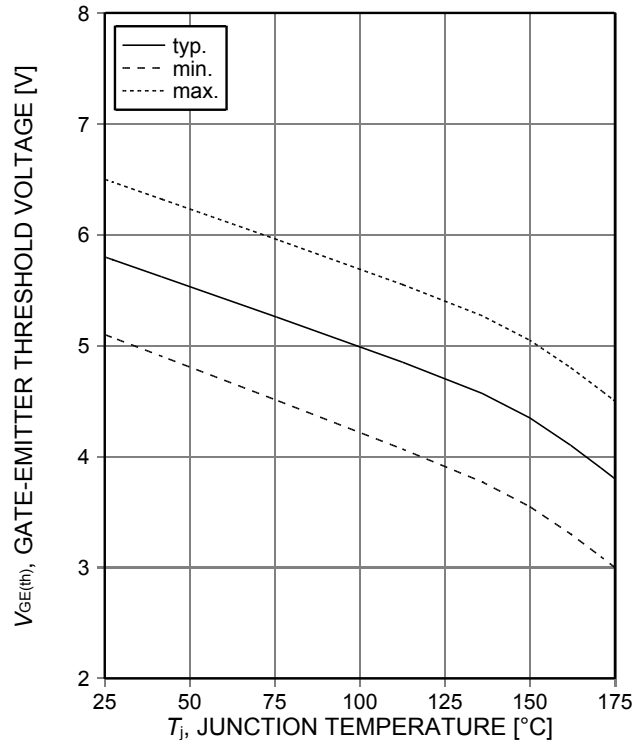


Figure 12. **Gate-emitter threshold voltage as a function of junction temperature**  
( $I_C=0.7\text{mA}$ )

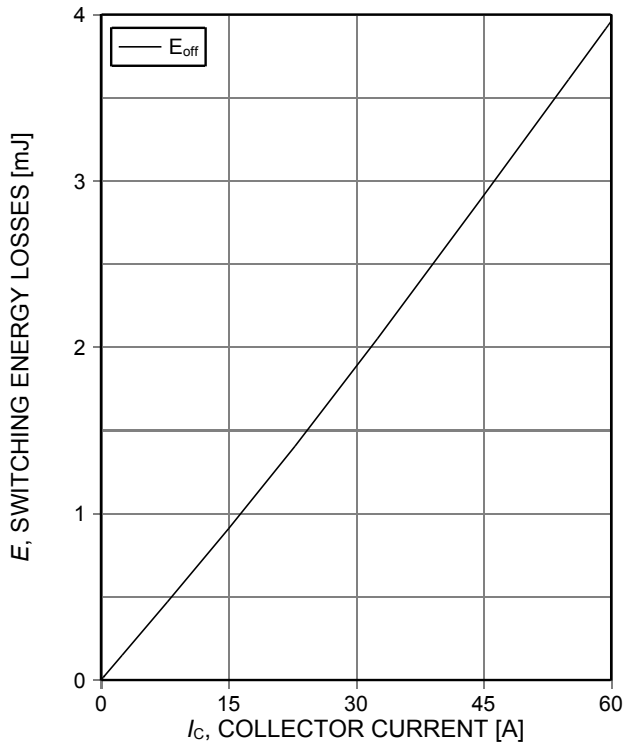


Figure 13. **Typical switching energy losses as a function of collector current**  
(ind. load,  $T_J=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $R_{G(on)}=15\Omega$ ,  $R_{G(off)}=15\Omega$ , test circuit in Fig. E)

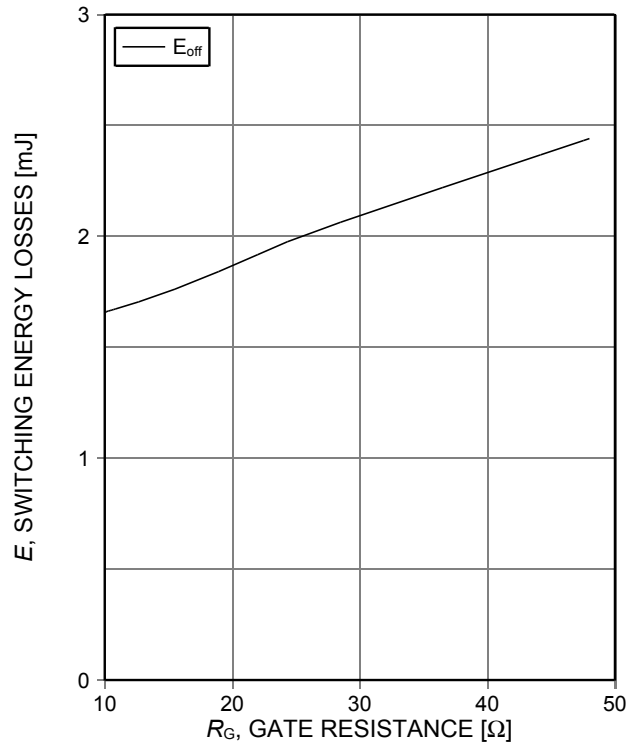


Figure 14. **Typical switching energy losses as a function of gate resistance**  
(ind. load,  $T_J=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ , test circuit in Fig. E)

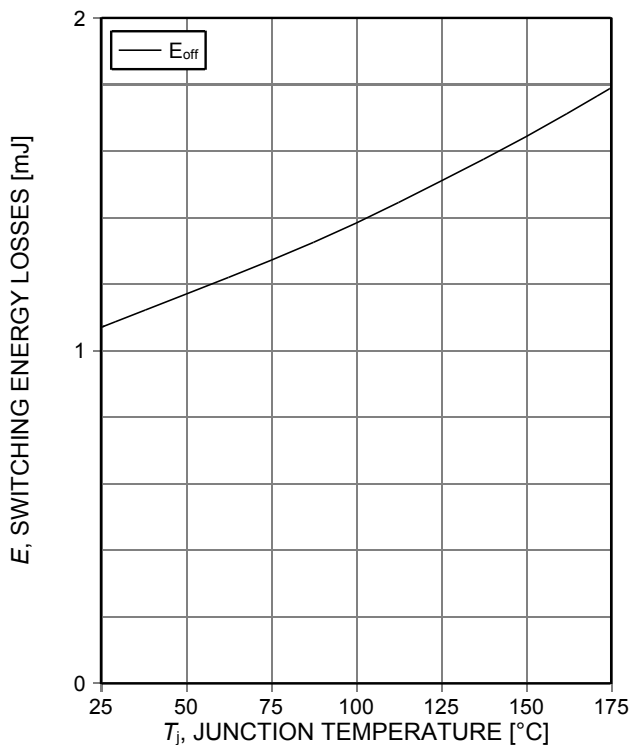


Figure 15. **Typical switching energy losses as a function of junction temperature**  
(ind load,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=30\text{A}$ ,  $R_{G(on)}=15\Omega$ ,  $R_{G(off)}=15\Omega$ , test circuit in Fig. E)

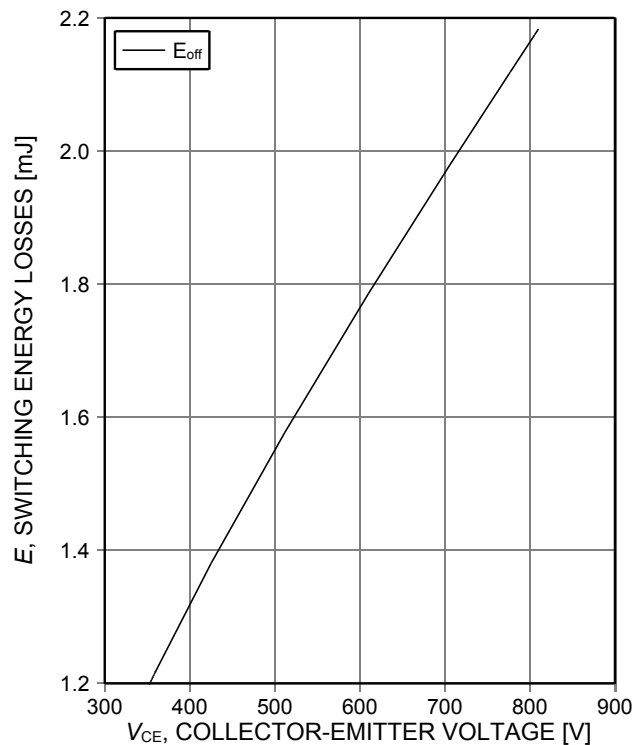


Figure 16. **Typical switching energy losses as a function of collector emitter voltage**  
(ind. load,  $T_J=175^\circ\text{C}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=30\text{A}$ ,  $R_{G(on)}=15\Omega$ ,  $R_{G(off)}=15\Omega$ , test circuit in Fig. E)

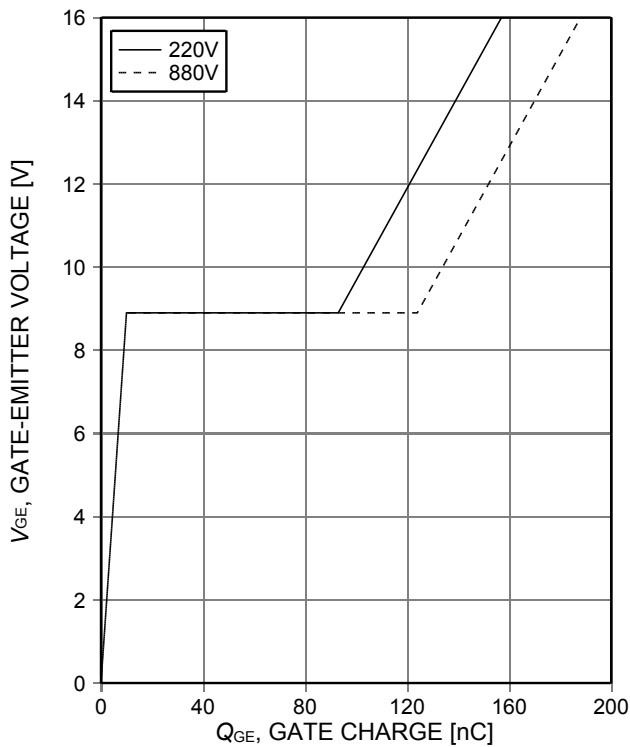


Figure 17. **Typical gate charge**  
( $I_C=30A$ )

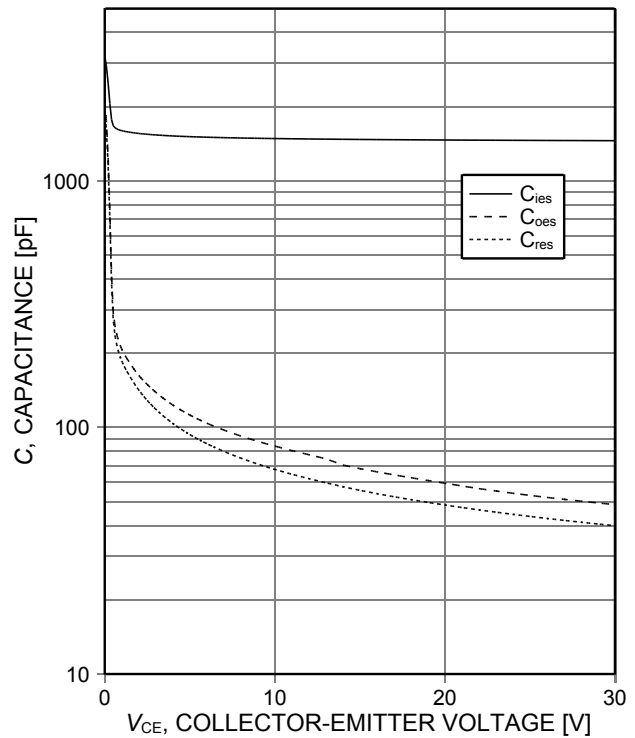


Figure 18. **Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE}=0V$ ,  $f=1MHz$ )

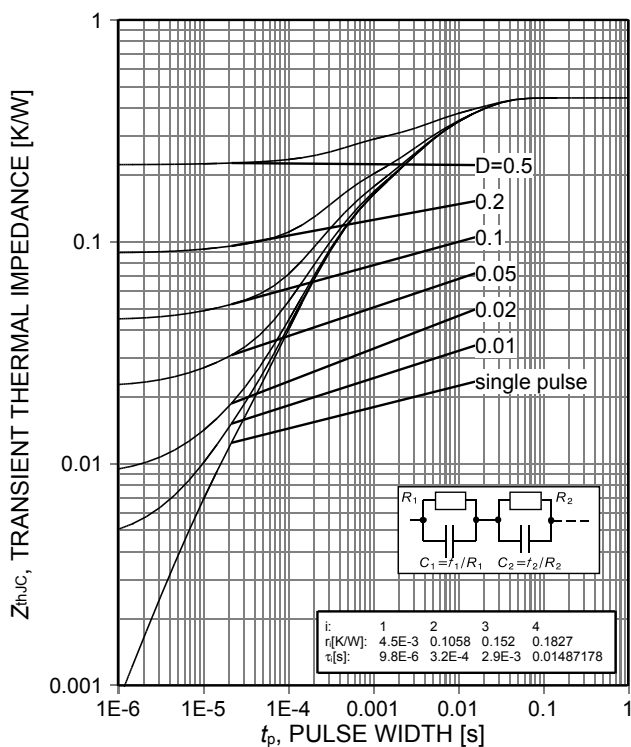


Figure 19. **IGBT transient thermal impedance**  
( $D=t_p/T$ )

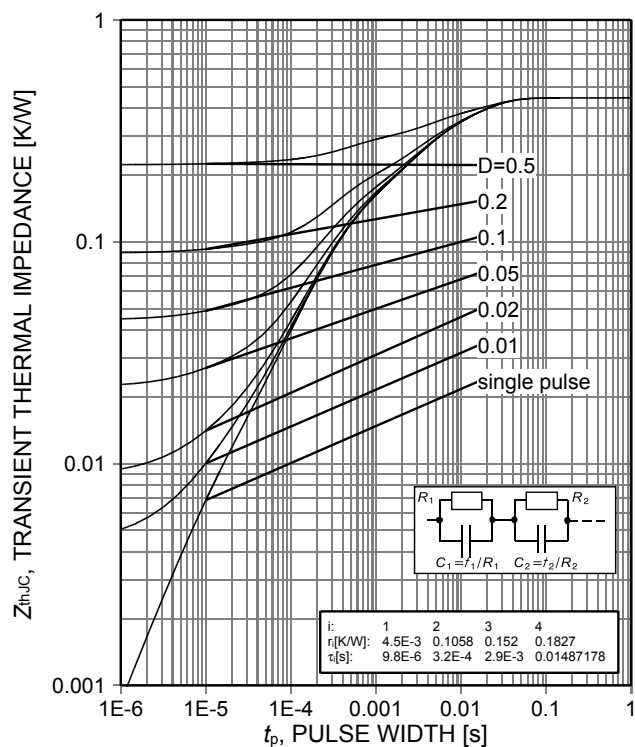


Figure 20. **Diode transient thermal impedance as a function of pulse width**  
( $D=t_p/T$ )

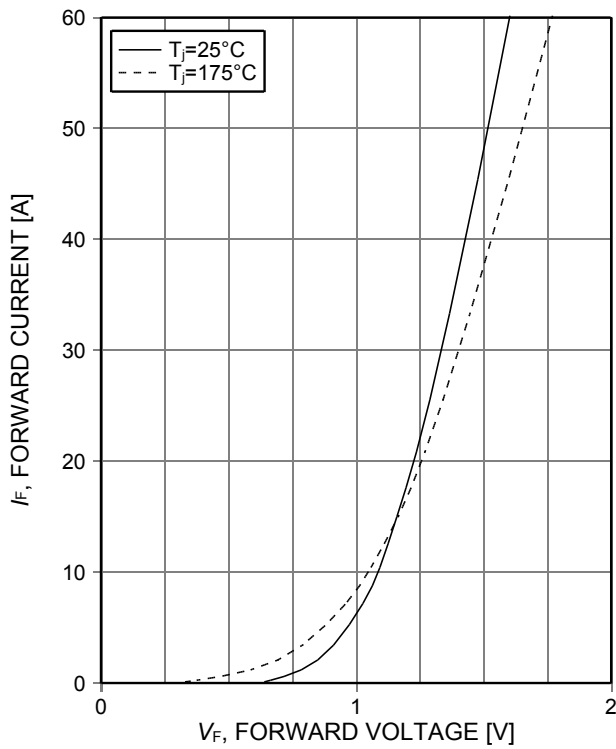


Figure 21. Typical diode forward current as a function of forward voltage

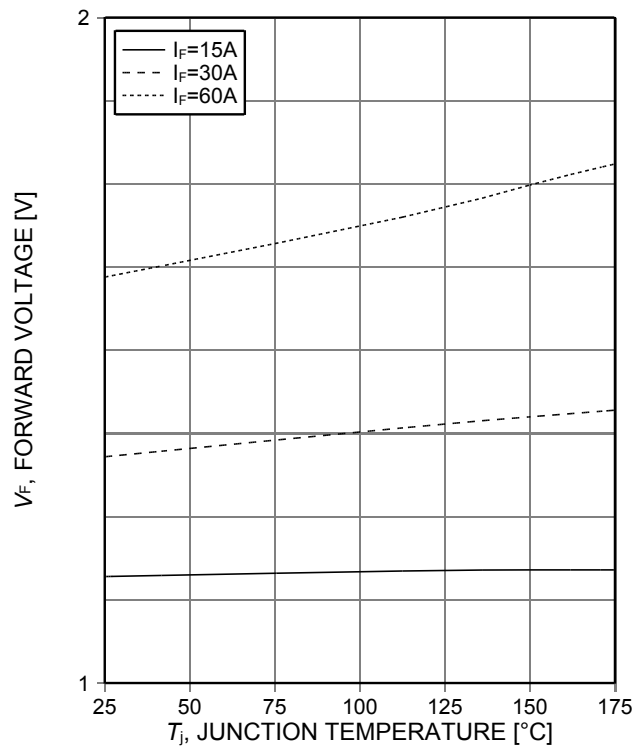
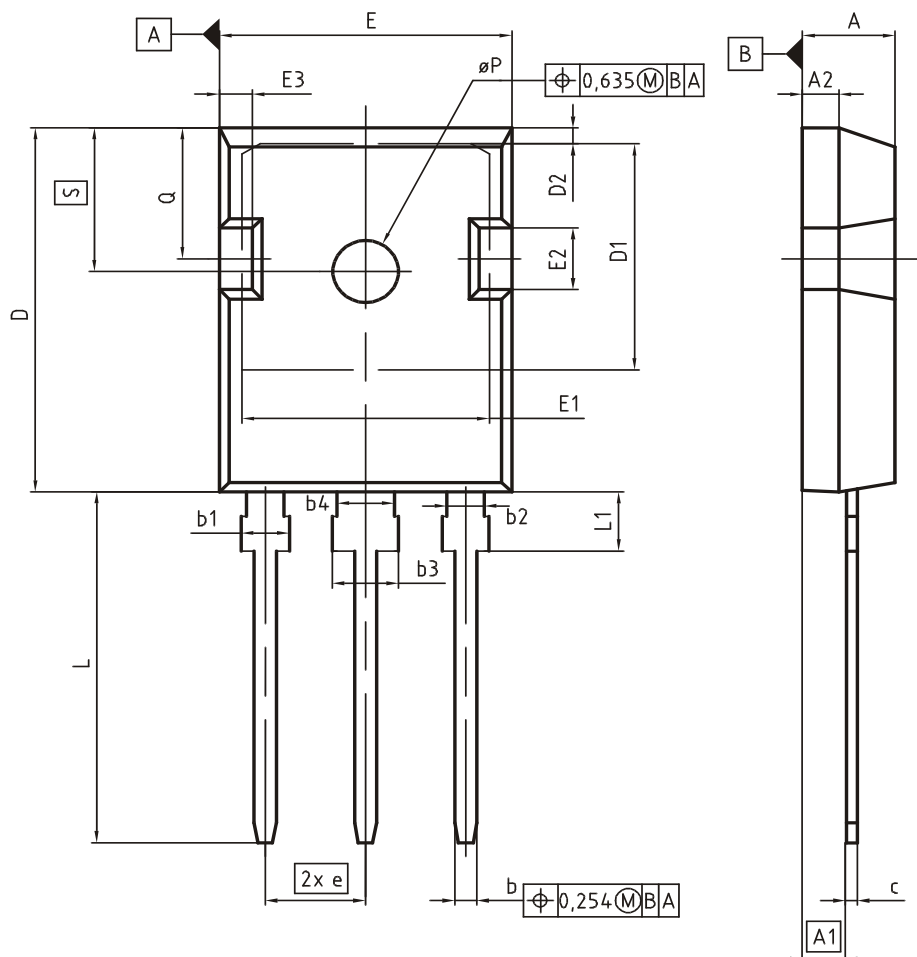


Figure 22. Typical diode forward voltage as a function of junction temperature

## PG-TO247-3



| DIM | MILLIMETERS |       | INCHES      |       |
|-----|-------------|-------|-------------|-------|
|     | MIN         | MAX   | MIN         | MAX   |
| A   | 4.83        | 5.21  | 0.190       | 0.205 |
| A1  | 2.27        | 2.54  | 0.089       | 0.100 |
| A2  | 1.85        | 2.16  | 0.073       | 0.085 |
| b   | 1.07        | 1.33  | 0.042       | 0.052 |
| b1  | 1.90        | 2.41  | 0.075       | 0.095 |
| b2  | 1.90        | 2.16  | 0.075       | 0.085 |
| b3  | 2.87        | 3.38  | 0.113       | 0.133 |
| b4  | 2.87        | 3.13  | 0.113       | 0.123 |
| c   | 0.55        | 0.68  | 0.022       | 0.027 |
| D   | 20.80       | 21.10 | 0.819       | 0.831 |
| D1  | 16.25       | 17.65 | 0.640       | 0.695 |
| D2  | 0.95        | 1.35  | 0.037       | 0.053 |
| E   | 15.70       | 16.13 | 0.618       | 0.635 |
| E1  | 13.10       | 14.15 | 0.516       | 0.557 |
| E2  | 3.68        | 5.10  | 0.145       | 0.201 |
| E3  | 1.00        | 2.60  | 0.039       | 0.102 |
| e   | 5.44 (BSC)  |       | 0.214 (BSC) |       |
| N   | 3           |       | 3           |       |
| L   | 19.80       | 20.32 | 0.780       | 0.800 |
| L1  | 4.10        | 4.47  | 0.161       | 0.176 |
| øP  | 3.50        | 3.70  | 0.138       | 0.146 |
| Q   | 5.49        | 6.00  | 0.216       | 0.236 |
| S   | 6.04        | 6.30  | 0.238       | 0.248 |

|                                                                                                                     |
|---------------------------------------------------------------------------------------------------------------------|
| <b>DOCUMENT NO.</b><br>Z8B00003327                                                                                  |
| <b>SCALE</b><br>0 5 7.5mm                                                                                           |
| <b>EUROPEAN PROJECTION</b><br> |
| <b>ISSUE DATE</b><br>09-07-2010                                                                                     |
| <b>REVISION</b><br>05                                                                                               |

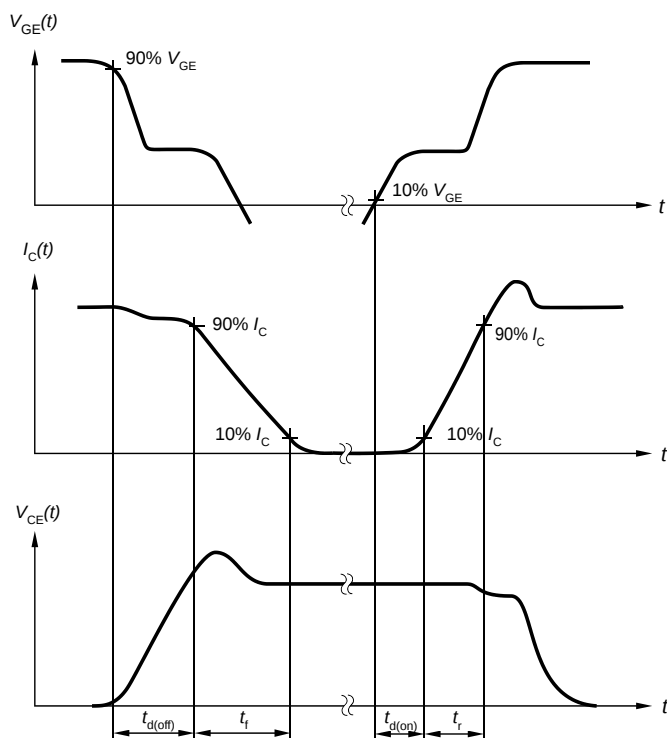


Figure A. Definition of switching times

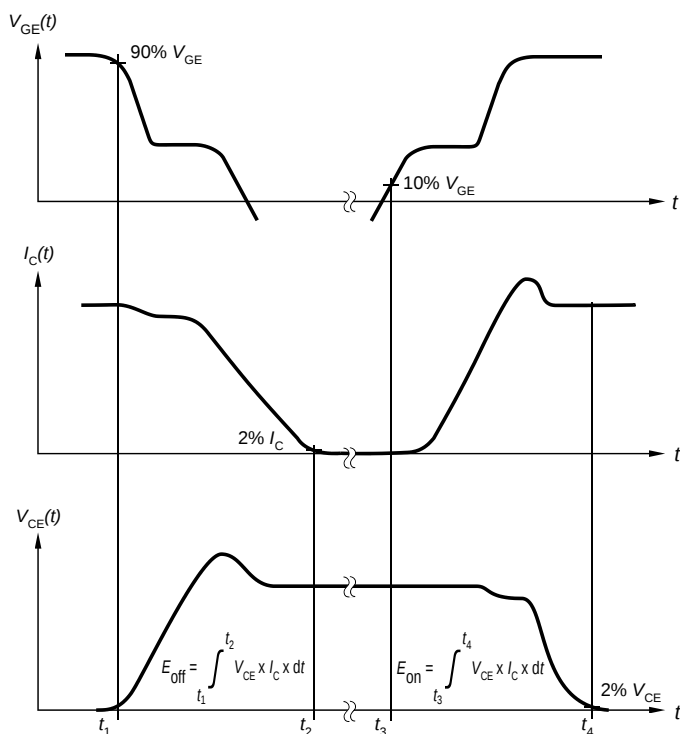
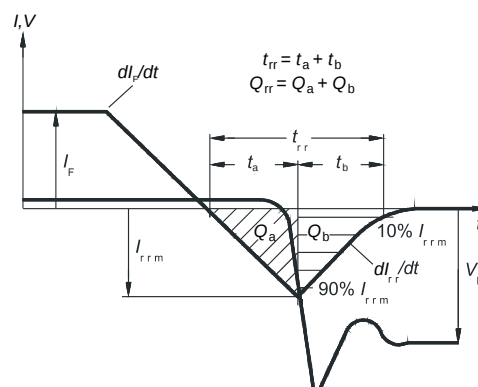


Figure B. Definition of switching losses



**Figure C. Definition of diode switching characteristics**

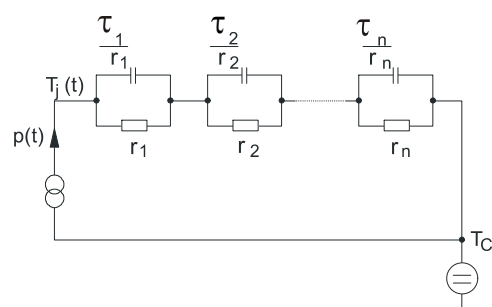


Figure D. Thermal equivalent circuit

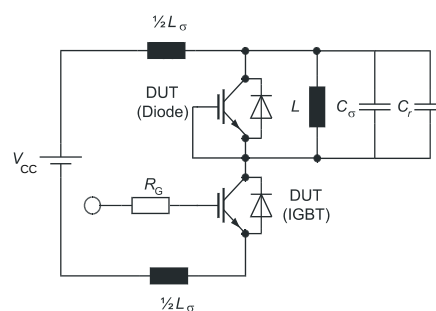


Figure E. **Dynamic test circuit**  
Parasitic inductance  $L_{\sigma}$ ,  
parasitic capacitor  $C_{\sigma}$ ,  
relief capacitor  $C_r$ ,  
(only for ZVT switching)

## Revision History

IHW30N110R3

Revision: 2015-01-26, Rev. 2.1

### Previous Revision

| Revision | Date       | Subjects (major changes since last revision) |
|----------|------------|----------------------------------------------|
| 1.1      | 2009-12-01 | -                                            |
| 1.2      | 2011-01-21 | Package drawing Rev. 05                      |
| 1.3      | 2013-02-12 | Layout change                                |
| 2.1      | 2015-01-26 | Final data sheet                             |

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## Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

The Infineon Technologies component described in this Data Sheet may be used in life-support devices or systems and/or automotive, aviation and aerospace applications or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support, automotive, aviation and aerospace device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,  
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: [ocean@oceanchips.ru](mailto:ocean@oceanchips.ru)

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А